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Diodes Incorporated
DMP2070UCB6-7

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DMP2070UCB6

P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary(Typ. @ V_{GS} = -4.5V, T_A = +25°C)

V _{DSS}	R _{DS(on)}	Qg	Q _{gd}	ID
-20V	55mΩ	2.9nC	0.5nC	-3.5A

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(on)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- **Battery Management**
- Load Switch

Battery Protection

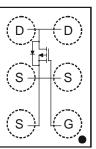
Features and Benefits

- LD-MOS Technology with the Lowest Figure of Merit: $R_{DS(on)} = 55m\Omega$ to Minimize On-State Losses Q_q = 2.9nC for Ultra-Fast Switching
- V_{as(th)} = -0.6V typ. for a Low Turn-On Potential
- CSP with Footprint 1.5mm x 1.0mm
- Height = 0.62mm for Low Profile
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: U-WLB1510-6
- Terminal Connections: See Diagram Below
- Weight: 0.0018 grams (Approximate)

U-WLB1510-6



Top View

Ordering Information (Note 4)

Part Number DMP2070UCB6-7		Case	Packaging					
		U-WLB1510-6	3,000/Tape & Reel					
Notes:	Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.							

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and

<1000ppm antimony compounds

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

U-WLB1510-6



2W = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011)M = Month (ex: 9 = September)

Date Code Key												
Year	201	1	2012		2013	20	14	2015		2016	2	2017
Code	Y		Z		А	E	3	С		D		E
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

DMP2070UCB6 Document number: DS35553 Rev. 3 - 2

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Maximum Ratings ($@T_A = +25^{\circ}C$ unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Drain-Source Voltage		V _{DSS}	-20	V	
Gate-Source Voltage			V _{GSS}	±8	V
Continuous Drain Current (Note 4) V_{GS} = -4.5V	Steady State	T _A = +25°C T _A = +70°C	ID	-2.5 -2.0	А
Continuous Drain Current (Note 5) $V_{GS} = -4.5V$ Steady State $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$			ID	-3.5 -2.8	А
Pulsed Drain Current (Note 6)		I _{DM}	-12	A	
Maximum Continuous Body Diode Forward Curren	t (Note 5)	I _S	-1.8	A	

Thermal Characteristics (@T_A = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 4)	PD	0.92	W
Total Power Dissipation (Note 5)	PD	1.47	W
Thermal Resistance, Junction to Ambient (Note 4)	R _{0JA}	136	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	R ₀ JA	84	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C unless otherwise specified.)

						1	
Characteristic	S	ymbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)							•
Drain-Source Breakdown Voltage	I	BV _{DSS}	-20	-	-	V	$V_{GS} = 0V, I_D = -250 \mu A$
Zero Gate Voltage Drain Current @T _C	; = +25°C	I _{DSS}	-	-	-1	μA	$V_{DS} = -16V, V_{GS} = 0V$
Gate-Source Leakage		I _{GSS}	-	-	±100	nA	$V_{GS} = \pm 8V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Ň	VGS(th)	-0.4	-0.6	-1.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
				55	70		V _{GS} = -4.5V, I _D = - 1A
Static Drain-Source On-Resistance				70	90	mΩ	$V_{GS} = -2.5V, I_D = -1A$
Static Drain-Source On-Resistance	ĸ	DS (ON)	-	90	110	1112	$V_{GS} = -1.8V, I_D = -1A$
				110	150		$V_{GS} = -1.5V, I_{D} = -1A$
Forward Transfer Admittance		Y _{fs}	-	12	-	S	V _{DS} = -10V, I _D = -1A
Diode Forward Voltage (Note 5)		V _{SD}	-	-0.7	-1	V	$V_{GS} = 0V, I_{S} = -1A$
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance		Ciss	-	210	-	pF	
Output Capacitance		Coss	-	92	-	pF	V _{DS} = -10V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance		Crss	-	38	-	pF	
Series Gate Resistance		R _G		5.3	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (4.5V)		Qg	-	2.9	-	nC	
Gate-Source Charge		Q _{gs}	-	0.3	-	nC	$V_{GS} = -4.5V, V_{DS} = -10V,$
Gate-Drain Charge		Q _{qd}	-	0.5	-	nC	I _D = -1A ,
Turn-On Delay Time		t _{D(on)}	-	7.3	-	ns	
Turn-On Rise Time		tr	-	14.0	-	ns	$V_{DD} = -10V, V_{GS} = -4.5V,$
Turn-Off Delay Time		t _{D(off)}	-	42.6	-	ns	$I_{DS} = -1A, R_{G} = 20\Omega,$
Turn-Off Fall Time		t _f	-	32	-	ns	1

Notes: 4. Device mounted on FR-4 PCB with minimum recommended pad layout.

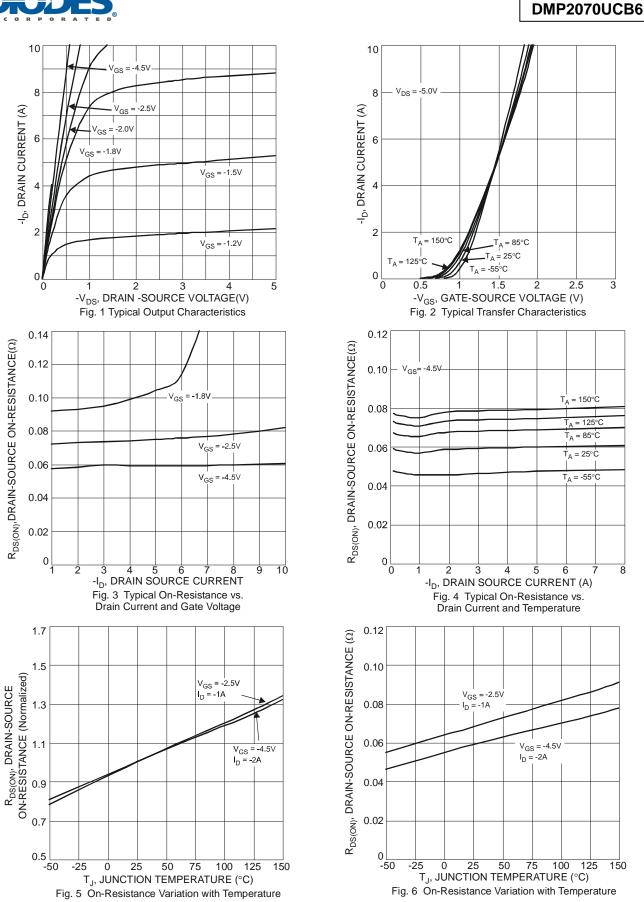
5. Device mounted on FR4 material with 1-inch² (6.45-cm²), 2-oz. (0.071-mm thick) Cu.

6 300ms pulse, pulse duty cycle ≤ 2%.

7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to production testing.

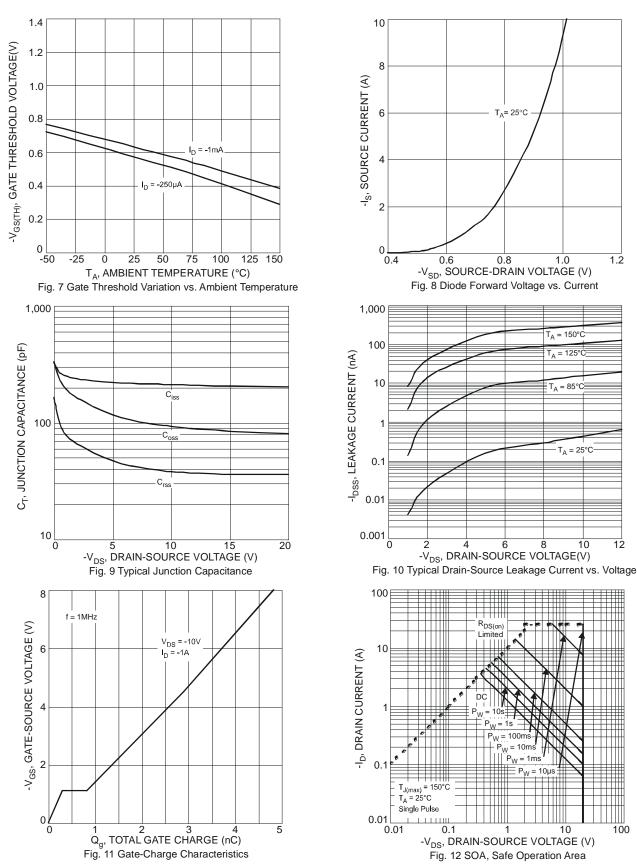




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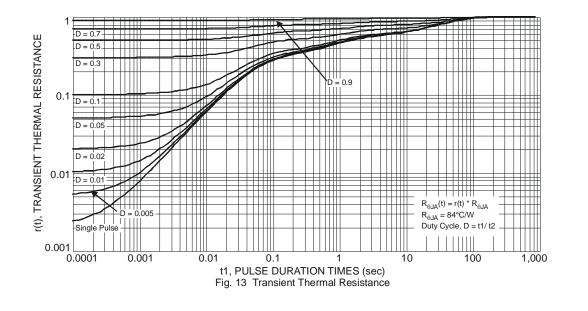
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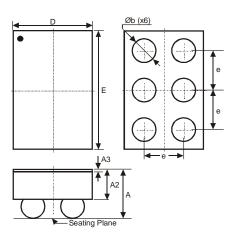


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Package Outline Dimensions

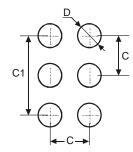
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



U-WLB1510-6								
Dim	Min	Max	Тур					
D	0.90	1.00	1.00					
Е	1.40	1.50	1.50					
Α	-	0.62	-					
A2	-	-	0.38					
A3	0.020	0.030	0.025					
b	0.27	0.37	0.32					
е	e – – 0.50							
All	Dimens	ions in r	nm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.50
C1	1.00
D	0.25





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